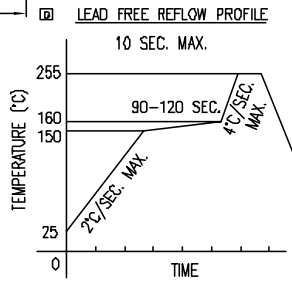
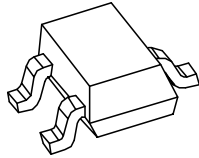
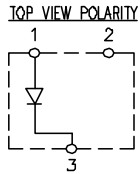
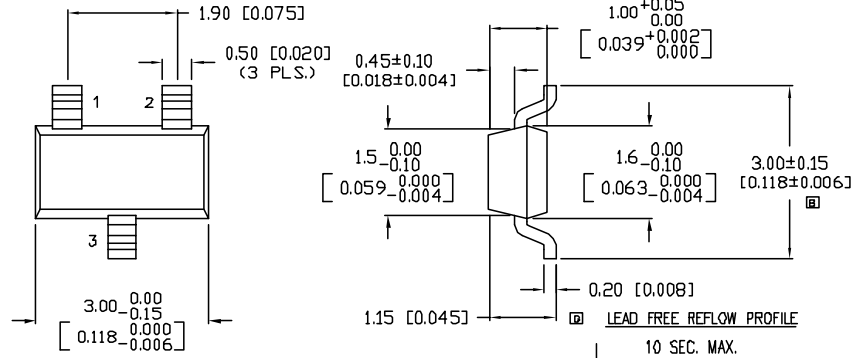
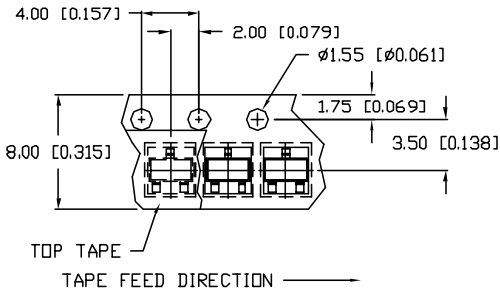
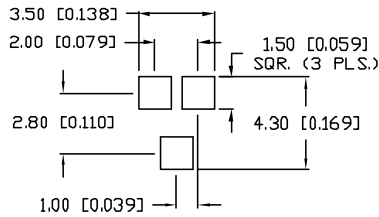


UNCONTROLLED DOCUMENT



TOTAL TIME ABOVE 220°C IS 60 SECONDS MAX.



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (0.002), LEAD LENGTH=±0.75 (±0.030). MIN= -0.00 DECIMAL PRECISION MAX.= +0.00 DECIMAL PRECISION

PART NUMBER
SSL-LX15IC-RP-TR

REV.
G

REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10165.	5.21.96
B	E.C.N. #10412.	4.28.98
C	E.C.N. #10BRDR. & REDRAWN.	1.15.01
D	E.C.N. #10752.	5.25.01
E	E.C.N. #10877.	6.10.02
F	E.C.N. #10901.	8.22.02
G	E.C.N. #11148.	2.23.05

ELECTRO-OPTICAL CHARACTERISTICS $T_A=25^\circ\text{C}$ $I_f=20\text{mA}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		635		nm	
FORWARD VOLTAGE		2.0	2.5	V_f	
REVERSE VOLTAGE	5.0			V_r	$I_r=100\mu\text{A}$
AXIAL INTENSITY		10		mcad	$I_f=20\text{mA}$
VIEWING ANGLE		140		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	WATER CLEAR				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	160	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	100	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-30 TO +85	°C

* $t < 10\mu\text{s}$

NOTES:

- ① 1. 3,000 PIECES PER REEL.
- ② 2. PIN 3 IS ORIENTED TOWARDS THE TAPE SPROCKET HOLE.
- ③ 3. LABEL MUST BE PERMANENTLY ATTACHED TO EACH REEL.



UNCONTROLLED DOCUMENT

REV. G PART NUMBER SSL-LX15IC-RP-TR

CONFIDENTIAL INFORMATION
THE INFORMATION CONTAINED IN THIS DOCUMENT IS THE PROPERTY OF LUMEX INC. EXCEPT AS SPECIFICALLY AUTHORIZED IN WRITING BY LUMEX INC., THE HOLDER OF THIS DOCUMENT SHALL KEEP ALL INFORMATION CONTAINED HEREIN CONFIDENTIAL AND SHALL PROTECT SAME IN WHOLE OR IN PART FROM DISCLOSURE AND DISSEMINATION TO ALL THIRD PARTIES.



290 E. HELEN ROAD
PALATINE, IL 60067-6976
PHONE: +1.847.359.2790
US WEB: www.lumex.com
TW WEB: www.lumex.com.tw

SOT-23 SURFACE MOUNT 635nm RED LED,
WATER CLEAR LENS, TAPE AND REEL.

RELIABILITY NOTE
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY: BC	CHECKED BY:	APPROVED BY:	DATE: 2.23.95
			PAGE: 1 OF 1
			SCALE: N/A